

EXPRESS MAIL NO.: EL179952502US

#3 103
11-21-00
R/States

Examiner: A. Chambliss
Art Unit: 2814
Docket No.: 52433/609

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.
Serial No. : To Be Assigned
Filed : Herewith
For : SEMICONDUCTOR DEVICE PROVIDED WITH LOW
MELTING POINT METAL BUMP AND PROCESS FOR
PRODUCING SAME

jc886 U.S. PTO
09/16/2010
08/04/00


Assistant Commissioner for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

SIR:

Enclosed herewith is a copy of completed form PTO-1449 listing references which may be of interest to the Patent and Trademark Office in the examination of the above-identified patent application. Copies of the listed references are also enclosed.

This application is a 37 C.F.R. §1.53(b) divisional application of prior application Serial No. 09/254,119. Process claims 7-15, under examination in this application, were withdrawn from consideration in prior application Serial No. 09/254,119 due to a restriction required.

Listed references U.S. Patent No. 4,940,181, U.S. Patent No. 5,833,128, and Japan No. 7-193068 were cited by the Examiner in prior application Serial No. 09/254,119. All other references listed on PTO-1449 were cited in the International Search Report for PCT/JP97/02987 from which the

present application derives. A copy of the International Search Report is also enclosed.

All references of record in prior application Serial No. 09/254,119 are listed on the attached form PTO-1449.

Respectfully submitted,
KENYON & KENYON

8/4/00

By: John J. Kelly, Jr.
John J. Kelly, Jr.
Reg. No. 29,182

KENYON & KENYON
One Broadway
New York, New York 10004
(212) 425-7200

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